

To all our customers

Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

BCR30AM

Refer to the page 6 as to the product guaranteed
maximum junction temperature 150°C

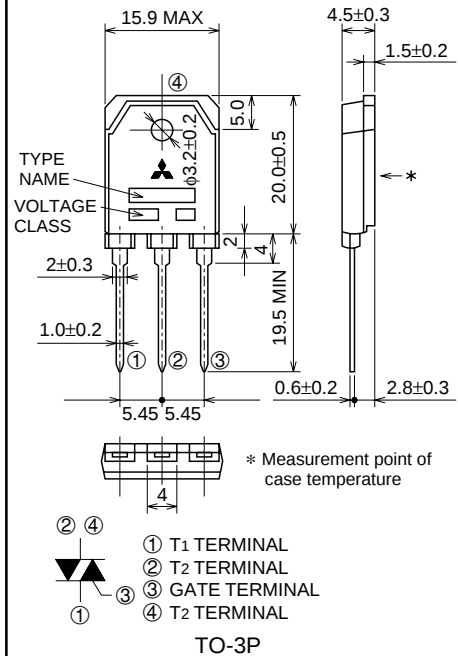
MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE

BCR30AM

- **IT (RMS)** **30A**
- **VDRM** **600V**
- **IFGT I , IRGT I , IRGT III** **50mA**

OUTLINE DRAWING

Dimensions
in mm

**APPLICATION**

Contactless AC switches, light dimmer,
on/off and speed control of small induction motors, on/off control of copier lamps,
microwave ovens

MAXIMUM RATINGS

Symbol	Parameter	Voltage class	Unit
		12	
VDRM	Repetitive peak off-state voltage *1	600	V
VDSM	Non-repetitive peak off-state voltage *1	720	V

Symbol	Parameter	Conditions	Ratings	Unit
IT (RMS)	RMS on-state current	Commercial frequency, sine full wave 360° conduction, Tc=75°C	30	A
ITSM	Surge on-state current	60Hz sinewave 1 full cycle, peak value, non-repetitive	300	A
I ² t	I ² t for fusing	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	378	A ² s
PGM	Peak gate power dissipation		5	W
PG (AV)	Average gate power dissipation		0.5	W
VGM	Peak gate voltage		10	V
IGM	Peak gate current		2	A
Tj	Junction temperature		-40 ~ +125	°C
Tstg	Storage temperature		-40 ~ +125	°C
—	Weight	Typical value	4.8	g

*1. Gate open.

Mar. 2002

BCR30AM

Refer to the page 6 as to the product guaranteed
maximum junction temperature 150°C

MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
IdRM	Repetitive peak off-state current	T _j =125°C, V _{DRM} applied	—	—	3.0	mA
V _{TM}	On-state voltage	T _c =25°C, I _{TM} =45A	—	—	1.6	V
V _{FGT} I	Gate trigger voltage *2	T _j =25°C, V _D =6V, R _L =6Ω, R _G =330Ω	—	—	2.5	V
V _{RGT} I			—	—	2.5	V
V _{RGT} III			—	—	2.5	V
I _{FGT} I	Gate trigger current *2	T _j =25°C, V _D =6V, R _L =6Ω, R _G =330Ω	—	—	50	mA
I _{RGT} I			—	—	50	mA
I _{RGT} III			—	—	50	mA
V _{GD}	Gate non-trigger voltage	T _j =125°C, V _D =1/2V _{DRM}	0.2	—	—	V
R _{th} (j-c)	Thermal resistance	Junction to case *3	—	—	1.2	°C/W
(dv/dt) _c	Critical-rate of rise of off-state commutating voltage *4	T _j =125°C	20	—	—	V/μs

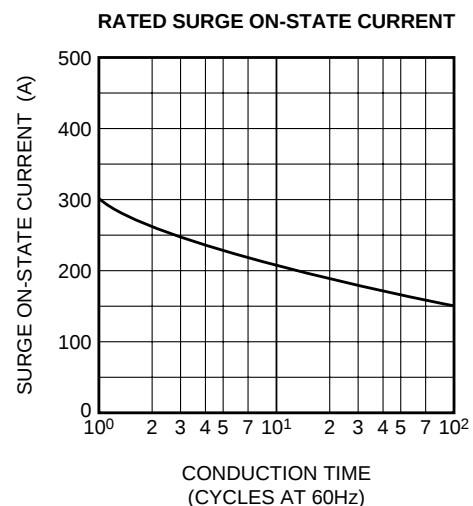
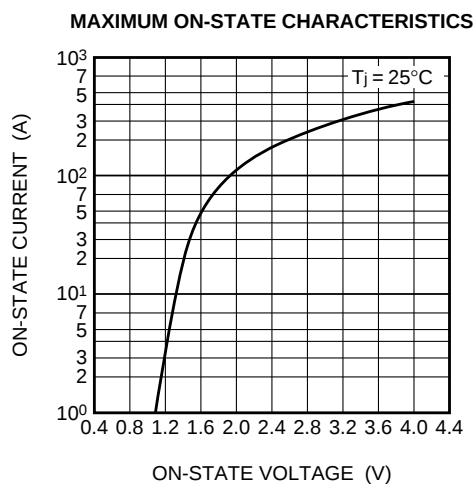
*2. Measurement using the gate trigger characteristics measurement circuit.

*3. The contact thermal resistance R_{th} (b-f) in case of greasing is 0.3°C/W.

*4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature T _j =125°C 2. Rate of decay of on-state commutating current (di/dt) _c =-16A/ms 3. Peak off-state voltage V _D =400V	

PERFORMANCE CURVES

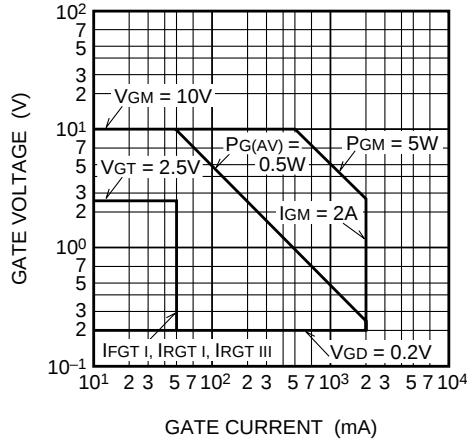


BCR30AM

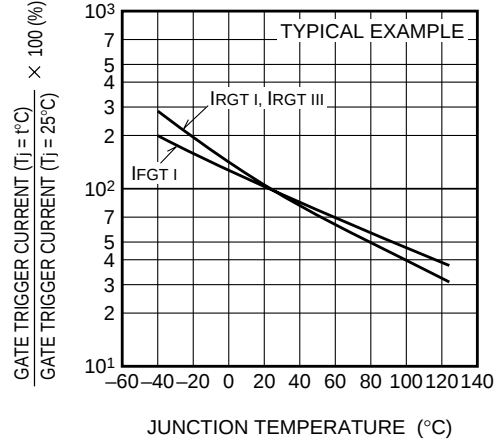
Refer to the page 6 as to the product guaranteed maximum junction temperature 150°C

MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE

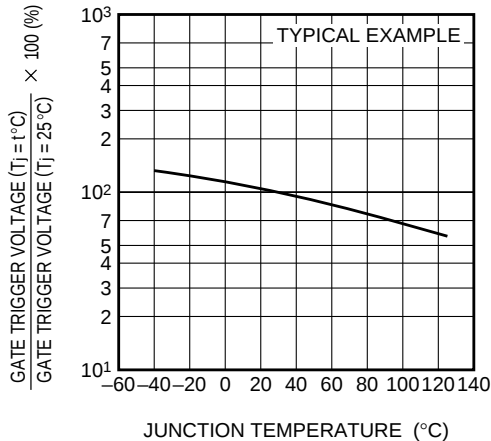
**GATE CHARACTERISTICS
(I, II AND III)**



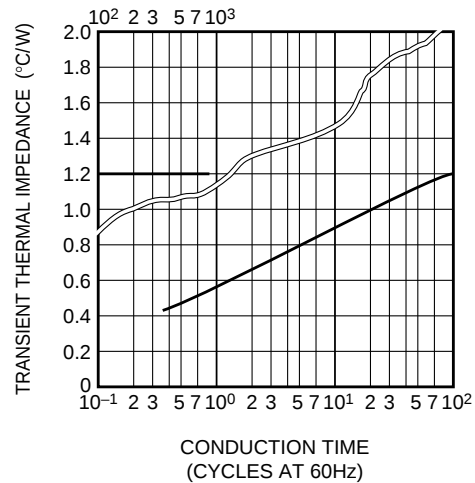
**GATE TRIGGER CURRENT VS.
JUNCTION TEMPERATURE**



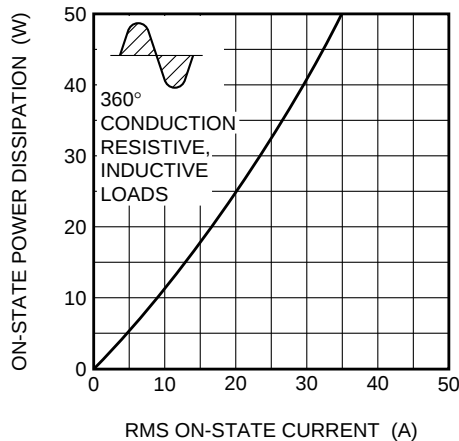
**GATE TRIGGER VOLTAGE VS.
JUNCTION TEMPERATURE**



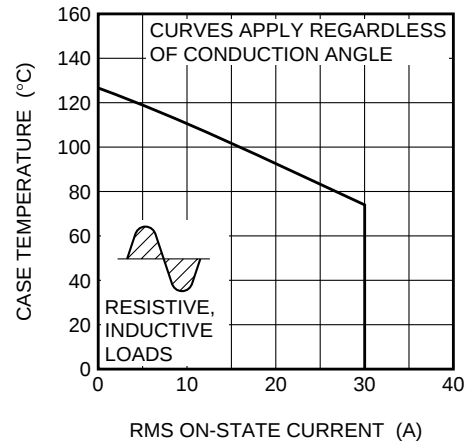
**MAXIMUM TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(JUNCTION TO CASE)**



**MAXIMUM ON-STATE POWER
DISSIPATION**



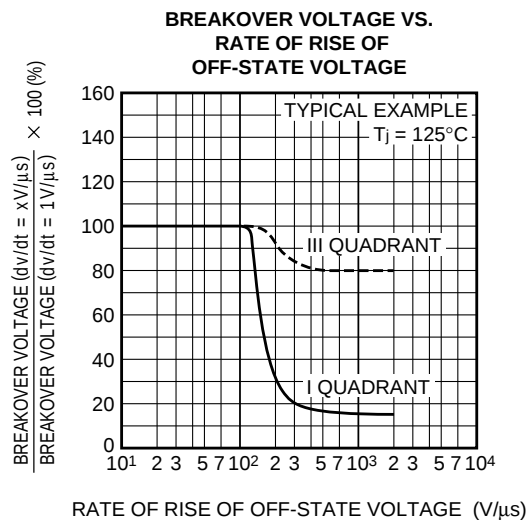
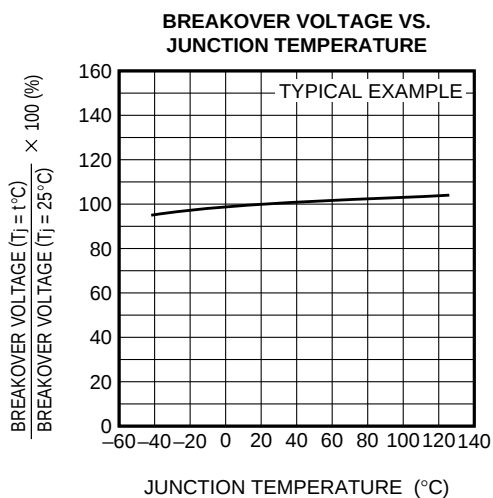
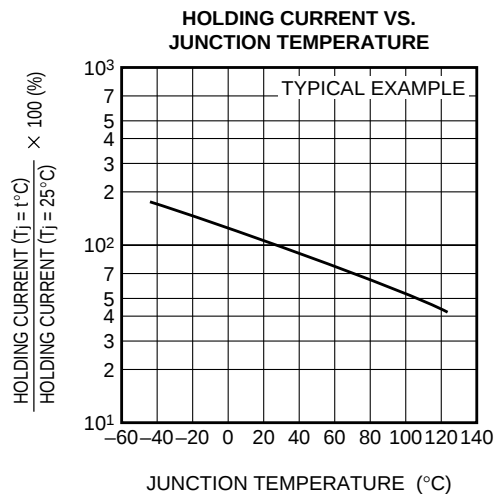
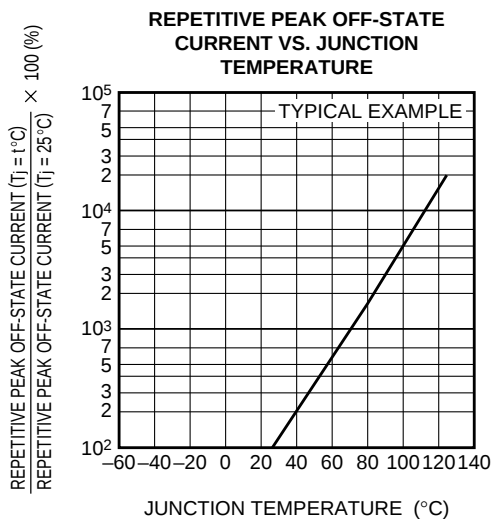
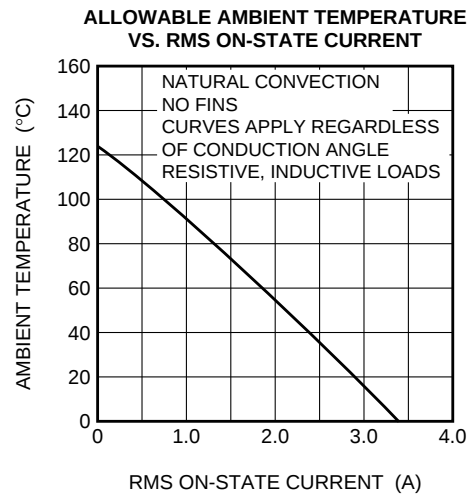
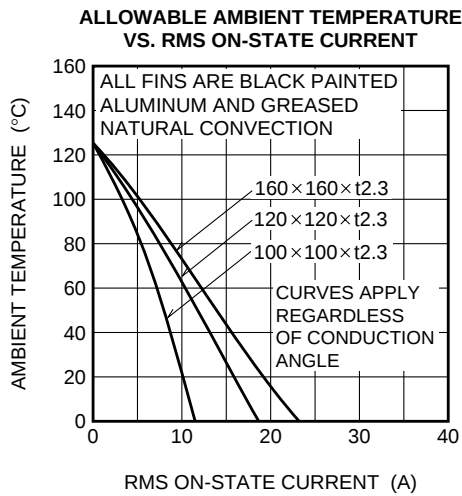
**ALLOWABLE CASE TEMPERATURE
VS. RMS ON-STATE CURRENT**



BCR30AM

Refer to the page 6 as to the product guaranteed
maximum junction temperature 150°C

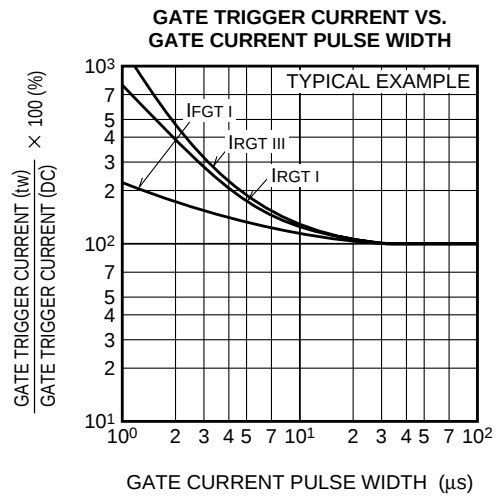
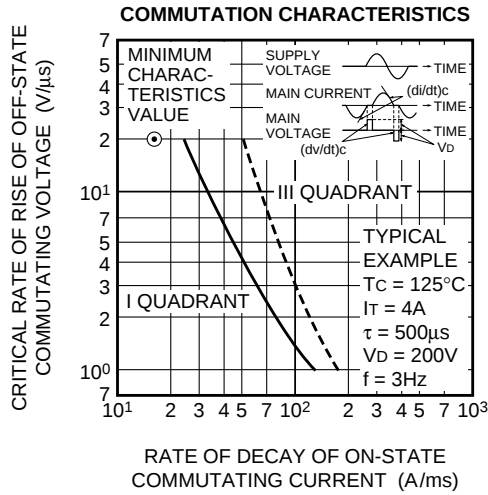
MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE



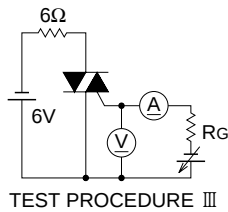
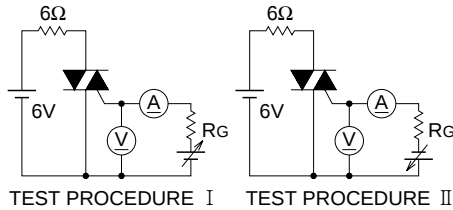
BCR30AM

Refer to the page 6 as to the product guaranteed
maximum junction temperature 150°C

MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE



GATE TRIGGER CHARACTERISTICS TEST CIRCUITS



BCR30AM

The product guaranteed maximum junction temperature 150°C (See warning.)

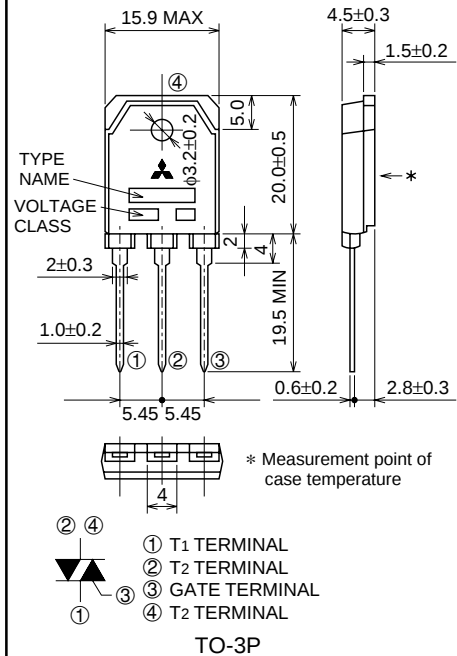
MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE

BCR30AM

- I_T (RMS) **30A**
- V_{DRM} **600V**
- $I_{FGT\ I}$, $I_{RGT\ I}$, $I_{RGT\ III}$ **50mA**

OUTLINE DRAWING

Dimensions
in mm

**APPLICATION**

Contactless AC switches, light dimmer,
on/off and speed control of small induction motors, on/off control of copier lamps,
microwave ovens

(Warning)

1. Refer to the recommended circuit values around the triac before using.
2. Be sure to exchange the specification before using. If not exchanged, general triacs will be supplied.

MAXIMUM RATINGS

Symbol	Parameter	Voltage class	Unit
		12	
V_{DRM}	Repetitive peak off-state voltage *1	600	V
V_{DSM}	Non-repetitive peak off-state voltage *1	720	V

Symbol	Parameter	Conditions	Ratings	Unit
I_T (RMS)	RMS on-state current	Commercial frequency, sine full wave 360° conduction, $T_c=100^\circ\text{C}$	30	A
I_{TSM}	Surge on-state current	60Hz sinewave 1 full cycle, peak value, non-repetitive	300	A
I^2t	I^2t for fusing	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	378	A ² s
PGM	Peak gate power dissipation		5	W
PG (AV)	Average gate power dissipation		0.5	W
VGM	Peak gate voltage		10	V
IGM	Peak gate current		2	A
T_j	Junction temperature		-40 ~ +150	°C
T_{stg}	Storage temperature		-40 ~ +150	°C
—	Weight	Typical value	4.8	g

*1. Gate open.

Mar. 2002

BCR30AM

The product guaranteed maximum junction temperature 150°C (See warning.)

MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
IdRM	Repetitive peak off-state current	T _J =125°C/150°C, V _{DRM} applied	—	—	3.0/5.0	mA
V _{TM}	On-state voltage	T _C =25°C, I _{TM} =45A	—	—	1.6	V
V _{FGT} I	Gate trigger voltage *2	T _J =25°C, V _D =6V, R _L =6Ω, R _G =330Ω	—	—	2.5	V
V _{RGT} I			—	—	2.5	V
V _{RGT} III			—	—	2.5	V
I _{FGT} I	Gate trigger current *2	T _J =25°C, V _D =6V, R _L =6Ω, R _G =330Ω	—	—	50	mA
I _{RGT} I			—	—	50	mA
I _{RGT} III			—	—	50	mA
V _{GD}	Gate non-trigger voltage	T _J =125°C/150°C, V _D =1/2V _{DRM}	0.2/0.1	—	—	V
R _{th} (j-c)	Thermal resistance	Junction to case *3	—	—	1.2	°C/W
(dv/dt) _c	Critical-rate of rise of off-state commutating voltage *4	T _J =125°C/150°C	20/2	—	—	V/μs

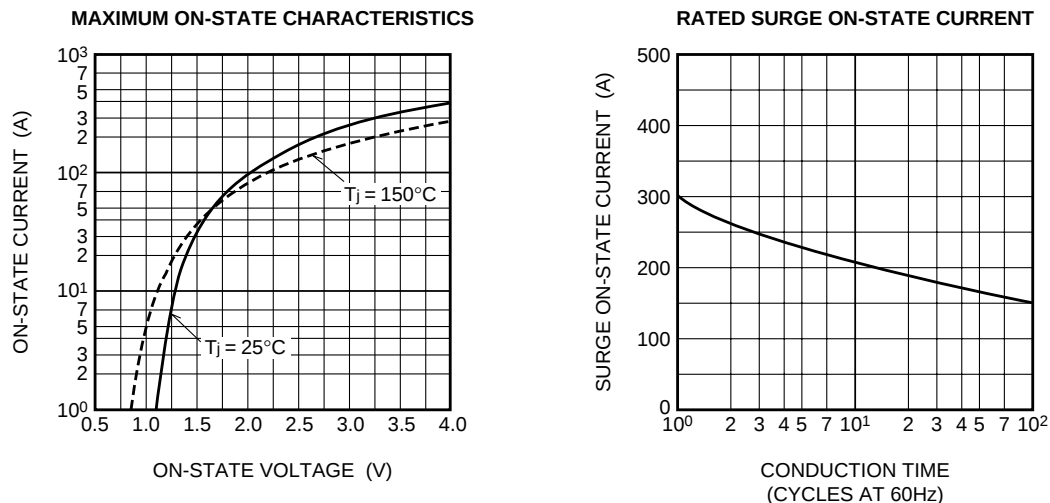
*2. Measurement using the gate trigger characteristics measurement circuit.

*3. The contact thermal resistance R_{th} (b-f) in case of greasing is 0.3°C/W.

*4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature T _J =125°C/150°C 2. Rate of decay of on-state commutating current (di/dt) _c =-16A/ms 3. Peak off-state voltage V _D =400V	

PERFORMANCE CURVES

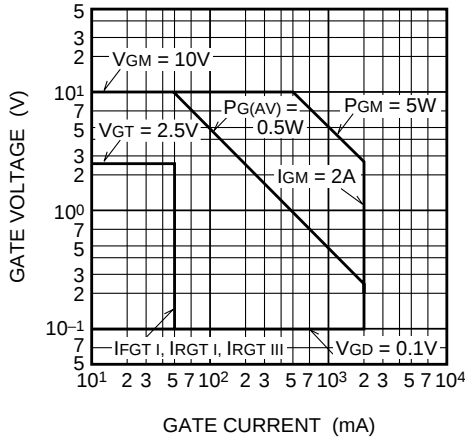


BCR30AM

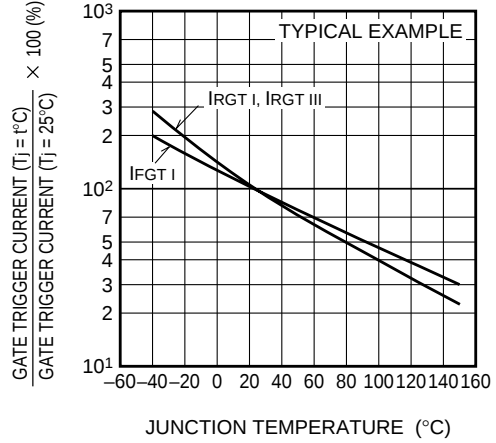
The product guaranteed maximum junction temperature 150°C (See warning.)

MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE

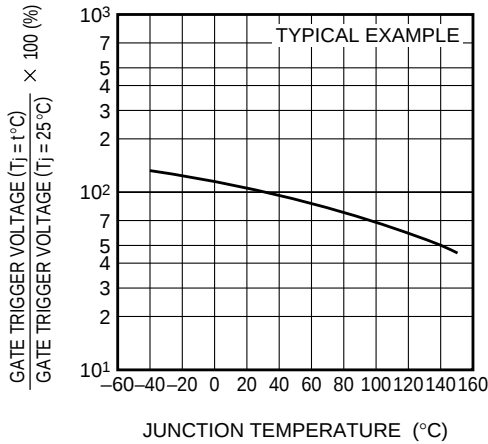
**GATE CHARACTERISTICS
(I, II AND III)**



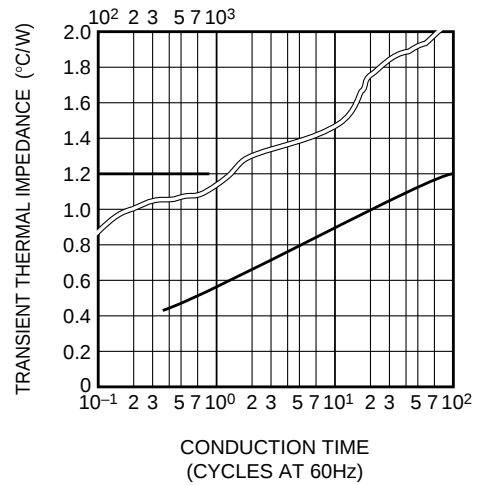
**GATE TRIGGER CURRENT VS.
JUNCTION TEMPERATURE**



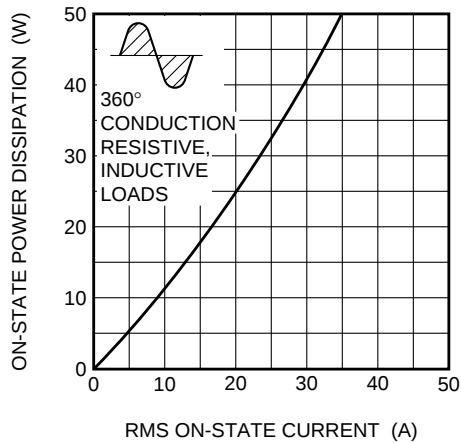
**GATE TRIGGER VOLTAGE VS.
JUNCTION TEMPERATURE**



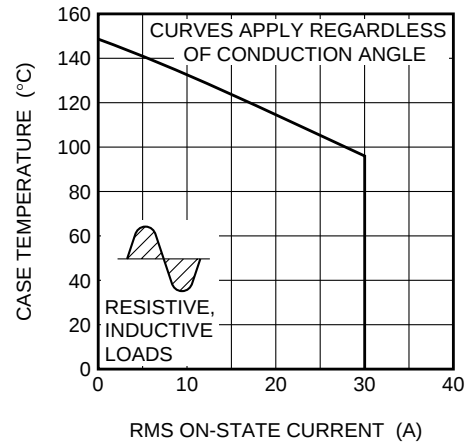
**MAXIMUM TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(JUNCTION TO CASE)**



**MAXIMUM ON-STATE POWER
DISSIPATION**



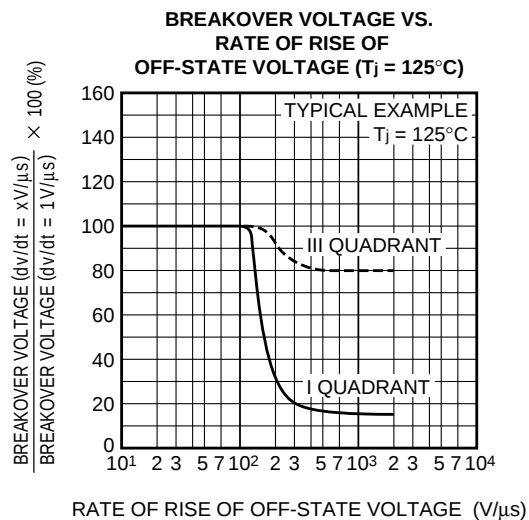
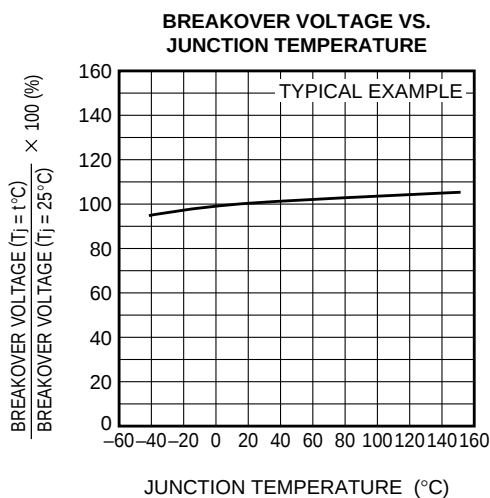
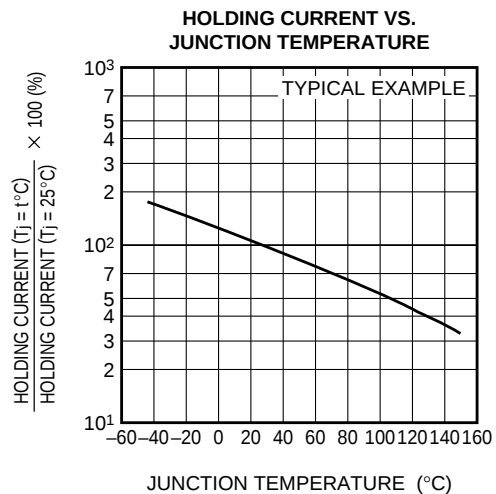
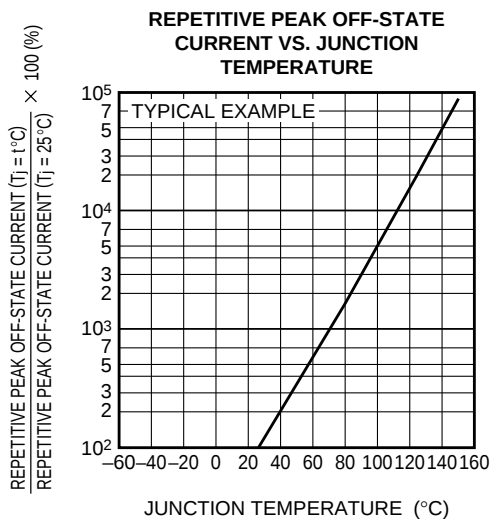
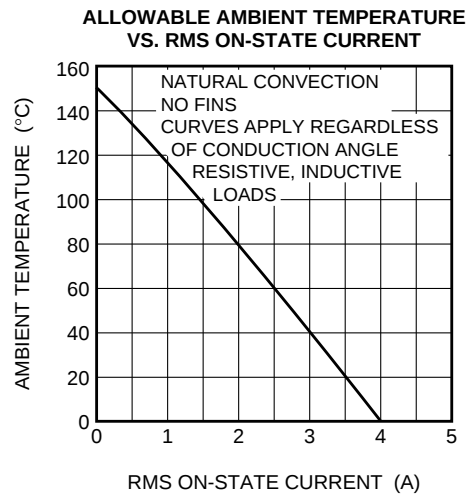
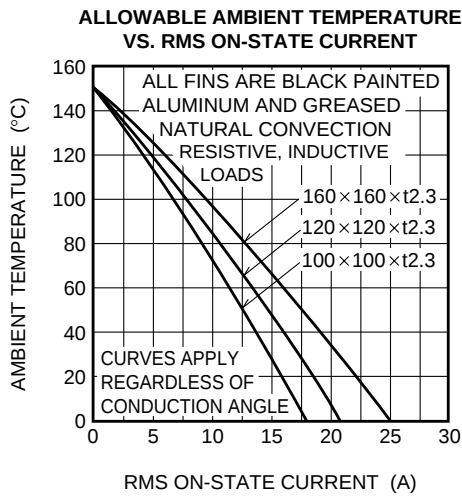
**ALLOWABLE CASE TEMPERATURE
VS. RMS ON-STATE CURRENT**



BCR30AM

The product guaranteed maximum junction temperature 150°C (See warning.)

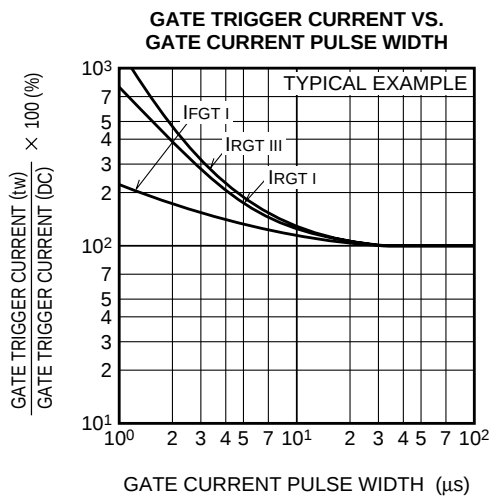
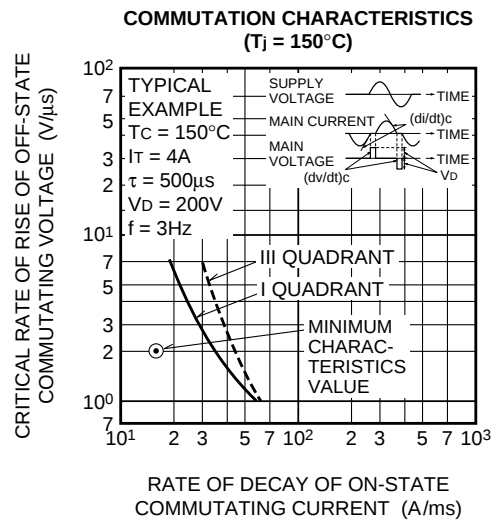
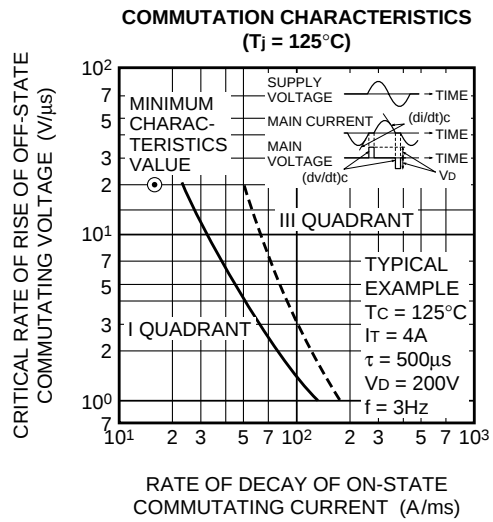
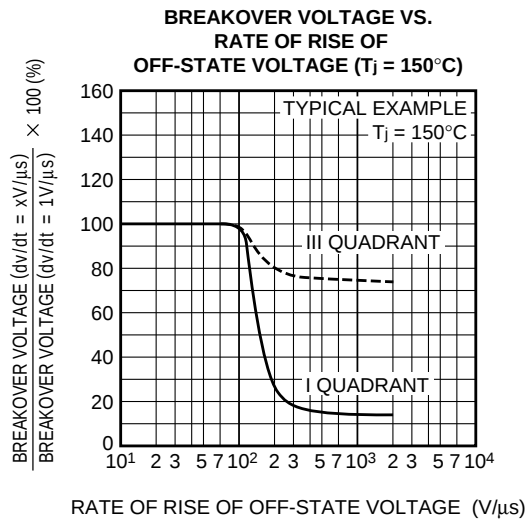
MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE



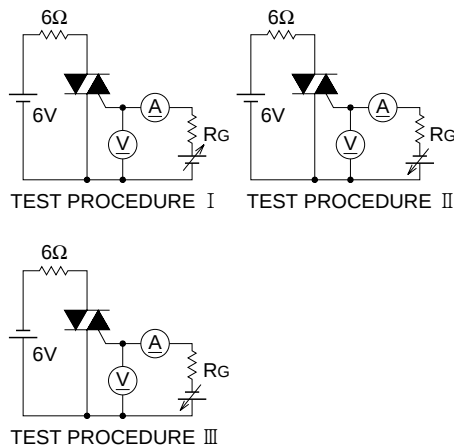
BCR30AM

The product guaranteed maximum junction temperature 150°C (See warning.)

MEDIUM POWER USE
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE



GATE TRIGGER CHARACTERISTICS TEST CIRCUITS



RECOMMENDED CIRCUIT VALUES AROUND THE TRIAC

